

Report No. MCR-22-0504 July 15,2022

# RENESAS SEMICONDUCTOR RELIABILITY REPORT

- GROUP : RL78/G10
- DEVICE : R5F10YXXX
- APPLICATION : Consumer / Industry

Quality Assurance Div. Renesas Electronics Corporation



MCR-22-0504

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## Table. Reliability test results (SOP)

Test Items	Reference	rence Test Conditions		Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-65 ℃ to 150 ℃ , 300 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JESD22-C101	+/-500V,1time	0/3	Class: C2
Solderability (SD)	J-STD-002	245 ℃, 5 s, Solder coverage ≥95 %	0/5	
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

\*1) With preconditioning per JESD22-A113, MSL 3 •It is tested to confirm that all the samples are satisfied with an individual product specification.

Note :

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .



The failure rate of the device in an actual use condition can be estimated by the below procedure.

# • Equation for the failure rate estimation ( $\lambda$ )

 $\lambda = \lambda b \times \pi T$  (FIT)

(1) Unique failure rate ( $\lambda b$ )

λb= 3.8 FIT

Unique failure rate at Ta=55  $^{\circ}$ C using 60  $^{\circ}$  confidence level.

②Temperature term ( $\pi$ T)

 $\pi$  T=exp{11600×Ea×(1/(273+55)-1/(273+Ta))}

Ea: Activation energy (eV)

Ta : Ambient temperature ( $^{\circ}$ C)

π	$\pi$ T simplified chart as Ea=0.7 eV												
	Га ℃)	40	50	55	60	65	70	75	80	85	90	100	110
Л	τΤ	0.31	0.68	1	1.45	2.08	2.95	4.15	5.77	7.96	10.88	19.82	34.99

# •MTTF ( Mean Time To Failure )

 $MTTF = 1/\lambda$ 



MCR-22-0504

### Reference about Renesas package code

Package type	Package code *1	
Lead type plastic package	QFP	PxQP
	SOP	PxSP
Non-lead type plastic package	QFN	PxQN
Grid array type plastic package	BGA	PxBG
	LGA	PxLG

\*1. First four digit

#### Table. Product list

No	Group	Product part number	Package code	No	Group	Product part number	Package code
1	RL78/G10	R5F10Y14ASP	PLSP0010J*	51			
2	RL78/G10	R5F10Y14DSP	PLSP0010J*	52			
3	RL78/G10	R5F10Y16ASP	PLSP0010J*	53			
4	RL78/G10	R5F10Y16DSP	PLSP0010J*	54			
5	RL78/G10	R5F10Y17ASP	PLSP0010J*	55			
6	RL78/G10	R5F10Y17DSP	PLSP0010J*	56			
7	RL78/G10	R5F10Y44ASP	PRSP0016J*	57			
8	RL78/G10	R5F10Y44DSP	PRSP0016J*	58			
9	RL78/G10	R5F10Y46ASP	PRSP0016J*	59			
10	RL78/G10	R5F10Y46DSP	PRSP0016J*	60			
11	RL78/G10	R5F10Y47ASP	PRSP0016J*	61			
12	RL78/G10	R5F10Y47DSP	PRSP0016J*	62			
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43	1	1		93	1		
44	1	1		94	1		
45		1		95			
46				96			
40 47				97			
47				97			
48 49		<u> </u>		98			
49 50	1	+		100	1		+
30	I	1	1	100			